	1		2		1	3	1		4			5		1	6	1	7		1	8		٦	
	Product Name:	ZX13	8-BTE60-ST Sa	umtec Breako	out Adapter	r										8⊙.				Pin1 J			
F	Product Description:	breakout adapter for test, debug, bringup applications. 60pins x 2rows, 120 pins breakout adapter supporting Samtec's 0.8mm ( 0.0315" ) pitch HI-SPEED Header / Socket BTE BSE Basic Blade & Beam connectors.														15 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	ZX13	F					
			exible two-piece			actor motio	a with Lloot		oppostor op	rico					(53mm)	424 504 58	⊐5254 interior	48 41	+4345	¢.5.¢	8-BT		
		ZX138-BTE60-ST has onboard BTE-060 connector, mating with Host BSE-060 connector series.    - Designed in 6 layer PCBoard											niit		Ŭ	66	-1618	64 57 L 72 65 L 80 73 L	+67 69 •75 77 •83 85	-70:	-BTE60-	-	
Е		- Imp - Mat - Ref - Higl - Mat	roved signal inte ching connector erence plane imp h bandwidth app es with Samtec	egrity and croa 's 50Ω imped pedance 50Ω lications. host BSE ser	ance.	or.				ALC IN						82 90 98 106 114 JZ	-184 86 C 11 - 1	8881- 9589- なか。 なか。 なか、 なか、	-1835- -19193- -14-9- -16-9- 	-87- :	SI S	E	
			D test point for e	-									100	and the second			• • •						
	The GND test point is connected to inner GND planes as well as top & bottom ground fills. Fully mated (ZX138-BTE60-ST with host, BSE) board clearance is 0.86" (22mm), enabling applications requiring horizontal access to device under test. 2.7" (68.56mm) Samtec BTE NOTE:												' [										
	Application: Bringup, testing, emulation, development, modular design evaluations										(2) ZX138-BTE60-ST ZEBAX.com						<b>NOTE:</b> 1- GND test point is connected to inner (			er GND plan			
U		-		-	-			ppostor			nm)			iom.		2- ZX138-BTE60-ST has onboard BTE connector, mating with Host BSE connector.						D	
Mates with : Samtec BSE-060 2 rows by 60 positions 0.8mm ( 0.0315" ) pitch centerline connector BSE-060-01-F-D-A BSE-060-01-L-D-A BSE-060-01-C-D-A											-	Header is standard 0.1" ( 2.54mm ) pitch.											
-	Pitch:0.80mm (0.0315") pitch Samtec High Speed connectorHeaders:0.1" (2.54mm) center, 0.025" (0.64mm) SQ with 0.23" (5.6mm) post height										4- Fully mated (ZX138-BTE60-ST with host, BSE) Simplified interface block diagram board clearance is 0.86" (22mm)									<u>-</u> )	-		
	Headers: 0.1" (2.5 Operating temperature			.6mm) post	neight																		
c Trance Impedance: 50 $\Omega$												1	с										
	Host																						
-	ZX138-BTE060-ST - 060 pin configuration - Labeled header pin number refers to BTE connector pins.												Ordering INFO: Part Number ZX138-BTE60-ST										
	<u>15</u> 7 15 23 31 39 47 55 63 71 79 87 95 103 111 119																						
в	_	14	5 13 3 11		29 37 27 35	45		61 69 59 67	77 75	85 83	93 91	101 99	109 107	117 115			Note					В	
	Top Headers	J4	1 9 8 16		25 33 32 40	41		57 65 64 72		81 88	89 96	97 104	105 112	113 120		ALL ZEBAX products are <b>RoHS</b> comp							
	_	J3 –	6 14		30 38	48		62 70		86	94	104	110	118			X TECI					_	
	J2       4       12       20       28       36       44       52       60       68       76       84       92       100       108       116         J2       10       18       26       34       42       50       58       66       74       82       90       98       106       114												CA U.S.A (831) 2 2 2 – 0717										
	BOTTOM BTE J1														SPECIFIE ARE INCH ROHS COL	D DIMENSION IES (MM). MPLIANT	<u>MBLY DF</u> [: ZX138-BT						
	Notice ALL ZEBAX TECHNOLOGIES DESIGN SPECI												RESSED,			DESCRI	DULION, Sai		out adapter l			- ^	
	IMPLIED, STATUTORY, OR OTHERWISE WIT Information furnished is believed to be accurate Specifications mentioned in this publication are	e and reliable	e. However, Zebax Technol	logies assumes no res	sponsibility for the co	onsequences of use	e of such information	or for any infringe	ment of patents or o	other rights of th	rd parties that r		n its use.			CHECKED:	2 ro MARINA	DWS X60 PI DRAWN: SLAVII	ns 0.80mm 0.	REVISSION:	1.0		
	1		2			3			4			5			6		7	SLAVI	<u> </u>	SHEET: 1 C	JF 1		